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## IN THE CLAIMS

1. (Currently amended) A device with a memory, the device comprising  
a matrix of static memory cells functionally arranged in rows and columns;  
bit line circuits, each for writing data to memory cells in a respective one of the  
columns;  
a word line circuit constructed so that the word line circuit is capable of selecting  
memory cells in a plurality of the rows simultaneously to receive write data from the bit  
line driver circuits;  
cell strength control circuitry coupled to the cells and arranged to reduce a supply  
voltage applied to individual ones of the memory cells and hence to reduce drive  
strengths required to write data into the individual ones of the memory cells, relative to a  
drive strength of the bit line circuits, in dependence upon a number of memory cells  
being simultaneously written, at least during simultaneous writing of data into the  
memory cells in a plurality of the rows.
2. (Previously presented) A device according to claim 1, wherein the cell strength control  
circuitry comprises a power supply reduction circuit coupled between a common power  
supply and an internal power supply line, the memory cells of at least one of the columns  
having power supply inputs coupled the internal power supply line, the power supply  
reduction circuit being arranged to provide a power supply voltage drop time-selectively  
at least during writing of data into the memory cells.
3. (Previously presented) A device according to claim 2, wherein the power supply

reduction circuit comprises a resistive element coupled between the common power supply and the internal power supply line.

4. (Previously presented) A device according to claim 2, wherein the resistive element comprises a transistor, with a main current channel coupled between the common power supply and the internal power supply line.

5. (Previously presented) A device according to claim 2, wherein the bit line circuit for the at least one of the columns comprises a bit-line driver circuit with a power supply input coupled to the internal power supply line.

6. (Previously presented) A device according to claim 5, wherein the bit-line driver circuit has a control input coupled to receive a control voltage derived from the common power supply line, substantially unaffected by said drop.

7. (Previously presented) A device according to claim 1, wherein the cell strength control circuitry comprises a plurality of power supply reduction circuits, each coupled between a common power supply and a respective internal power supply line, the memory cells in respective ones of the columns each having power supply inputs coupled a respective one of the internal power supply lines, each power supply reduction circuit being arranged to provide a respective power supply voltage drop on the respective one of the internal power supply lines to which that power supply reduction circuit is coupled, selectively at least during writing of data into the memory cells.

8. (Previously presented) A device according to claim 7, wherein each power supply reduction circuit comprises a resistive element coupled between the common power supply and a respective one of the internal power supply lines.

9. (Previously presented) A device according to claim 7, wherein the bit line circuit for each respective one of the columns comprises a respective bit-line driver circuit with a power supply input coupled to the internal power supply line of that respective one of the columns.

10. (Previously presented) A device according to claim 9, wherein each bit-line driver circuit has a control input coupled to receive a control voltage derived from the common power supply line, substantially unaffected by said drop.